半導體高階人才攬才 \_ 履歷格式

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| **\* Please fill out the form in English or Chinese 請使用英文或中文填寫此資料 \* Send this form via email 請將履歷寄至信箱** [**emmatsai@g-mail.nsysu.edu.tw**](mailto:emmatsai@g-mail.nsysu.edu.tw) **(Emma)** | | | | | | | | | | | | | | | | | | | | | | |
| **Job Applied For**  欲申請職務 | | | **1.** | | | | | | | | **2.** | | | | | | | | | | | |
| A. General Information 個人基本資料 | | | | | | | | | | | | | | | | | | | | | | |
| **Name**  姓名 | **Chinese**  中文 |  | | | | | | Nationality 國籍 | | | | | | | | 🞏 **R.O.C.** 中華民國 🞏 | | | | | | |
| **English**  英文 |  | | | | | | **Gender** 性別 | | | | | | | | 🞏**Male**男 🞏**Female**女 🞏**Prefer not to say**不透漏 | | | | | | |
| Phones 電話 | | | | (Tel)(Cell) | | | | | | | | | | | | | | | | | | |
| E-mail Address 電子郵件 | | | |  | | | | | | | | | | | | | | | | | | |
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| B. Education, Specialty & Language Ability 教育、專長與語文能力 | | | | | | | | | | | | | | | | | | | | | | |
| **Grade**  階段 | | | | **Name of School**  學校名稱 | **Major**  科系 | | **From**起 | | | | | **To**迄 | | | | | **Graduated**  是否畢業 | | | Type 日/夜間部 | | Highest Degree 最高學歷 |
| **M**月 | | | **Yr**年 | | **M**月 | | **Yr**年 | | | **Yes** | **No** | |
| **University**  大學 | | | |  |  | |  | | |  | |  | |  | | |  |  | | 🞏**Day** 日間部  🞏**Night**夜間部 | |  |
| **Post Graduate**  **(Master)**  研究所(碩士) | | | |  |  | |  | | |  | |  | |  | | |  |  | | 🞏**Day** 日間部  🞏**Night**夜間部 | |  |
| **Post Graduate**  **(PhD)**  研究所(博士) | | | |  |  | |  | | |  | |  | |  | | |  |  | |  | |  |
| **Other**  其他 | | | |  |  | |  | | |  | |  | | |  | |  |  | |  | |  |
| Describe any special vocational or technical training and specialized knowledge/skill (Required) 請說明您的專業知識與技能(必填) **In summary, key words of your expertise are:** 您專業技能的關鍵字詞為何(註：關鍵字有助加速將您的履歷派送至適合職缺) | | | | | | | | | | | | | | | | | | | | | | |
| **Language Ability:** indicate the language and your proficiency, i.e. Excellent, Good, Useful, A little, Not at all.  語文能力：請以極佳、佳、普通、略通或不通說明您對該語文的熟練程度 | | | | | | | | | | | | | | | | | | | | | | |
| **Second Language and so on**  第2、3...外國語 | | | | | | **Listening**  聽 | | | **Speaking**  說 | | | | **Reading**  讀 | | | | | | **Writing**  寫 | | **Remarks**  備註 | |
| **1. English** | | | | | |  | | |  | | | |  | | | | | |  | |  | |
| **2.** | | | | | |  | | |  | | | |  | | | | | |  | |  | |
| **3.** | | | | | |  | | |  | | | |  | | | | | |  | |  | |

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| **C. Professional Achievement & Honor** 專業成就 | | | |
| 1. **Publication on A Class Journal (e.g. Nature, IEEE, SPIE, JACS…etc.)**   **A級期刊論文含口頭表達 (例如: Nature, IEEE, SPIE, JACS 等)** | | | |
| **Journal**  期刊名稱 | **Title of the Publication**  論文題目 | **1st author or 1st author second to Professor**  第一作者或  次於教授後之第一作者 | **Year**  發表年 |
|  |  | 🞏Yes 🞏No |  |
|  |  | 🞏Yes 🞏No |  |

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| 1. **Invention /Patent**   **發明及專利** | | | | |
| Patent Name 發明/專利名稱 | **Date of Issue**  核准日 | **Patent Certificate No.**  證號 | **Country of Issue**  核發國 | |
| (1) |  |  |  | |
| (2) |  |  |  | |
| **5. License or Certificate**  **專業證照** | | | | |
| License or Certificate 專業證照或檢定證書 | **Date of Issue**  發照日 | **Certificate No.**  證照字號 | | **Remarks**  備註 |
| (1) |  |  | |  |
| (2) |  |  | |  |

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| D. Working Experience 工作經驗 | | | | | | | | | | | | | | |
| From 起 | | To 迄 | | Title /  On Grade Year  職稱/在職年資 | | | **Co. Name**  公司名稱  (請填入公司全名) | **Co. Location**  (Country)  公司所在地點 | | | **Reason**  **for Leaving**  離職原因 | | |
| **M**月 | **Yr**年 | **M**月 | **Yr**年 |
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| **May we contact your present employer?** 公司是否可與您的現任雇主聯絡查證 🞏 **No**否🞏 **Yes**是  **We shall not do so without your consent.** 未經您同意公司絕不會聯絡您的現任雇主 | | | | | | | | | | | | | | |
| **Describe your experience, major achievement during each of the period mentioned above.**  請摘要您於上述各職務的主要成就 | | | | | | | | | | | | | | |
| E. Others 其他 | | | | | | | | | | | | | | |
| **Reference Check :** Please provide minimum of three names. Your supervisor(s), research advisor(s) or teacher(s) must be included in.  資歷查核: 請至少提供三位查核對象，其中至少含直屬主管、論文指導教授或授課教師 | | | | | | | | | | | | | | |
| Name姓名 | | | | | **Relation**  關係 | **Company / Dept.**  公司/部門 | | **Title**  職稱 | **Contact**  聯絡方式 | | | | | |
|  | | | | |  |  | |  | (Tel)(Cell) | | | E-mail: | | |
|  | | | | |  |  | |  | (Tel)(Cell) | | | E-mail: | | |
|  | | | | |  |  | |  | (Tel)(Cell) | | | E-mail: | | |
|  | | | | | | | | | | Expected Salary 期望薪資 | | | NT$ | |
| Which channel did you learn the job opening? 您自何處得知此職缺 🞏 **Campus** 學校🞏 **Job bank**人力銀行🞏 **Newspaper ad.**報紙廣告  🞏 **Magazines** 雜誌 🞏 **Friends / Relatives**親友🞏 **Teachers/Advisors** 授課教師/指導教授  🞏 **Employment Service Office** 就業服務站 🞏 **Others** 其他，請說明**\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_** | | | | | | | | | | | | | | |
| **Additional information you wish to add** 其他補充資訊 | | | | | | | | | | | | | | |

**\*STIPC will collect, process and use the personal information you provided in this form in accordance with Personal Information Protection Act (Taiwan).   
For more detailed information, please refer to the last page of this form. 本中心將依照個人資料保護法蒐集、處理與利用您以下所提供的個人資料。詳細資訊請參照下一頁說明。**

**Notification and Letter of Consent for Collection, Processing and Use of Personal Information**

Version: P-V5x-RISD

According to the R.O.C. Personal Information Protection Act and the internal policy/regulations of **Industrial Development Bureau Ministry of Economic Affairs (hereinafter referred to as “IDB”), IDB** is obligated to make the following notification known to you before you provide personal information to IDB. Please read it carefully.

1. **Purposes and Categories of Personal Information to be Collected**

For the purpose of carrying out IDB’s business, activity or project, the purpose of providing service, internal administrative management or reporting to the competent authority, the purpose complying with the Endowment, or the purpose of sending IDB’s or industry relevant information, IDB needs you to provide these categories of personal information: Curriculum Vitae (Including Name, Email, Gender, Nationality, Phone number, Educational and work experience etc.)

Note: You may choose, at any time in the future, not to receive any promotional information from IDB by clicking the link provided in the promotional message.

1. **Time Period, Area, Target and Way of the Use of Personal Information**

Unless the purposes of use relating to international businesses or activities, your personal information will be used solely by IDB in a reasonable way in the territory of the Republic of China to the extent necessary to implement the purposes of collection until the purposes of collection prescribed above is fulfilled.

1. **Your Rights with regard to Personal Information Provided**

You may exercise the following rights in pursuant to the rules of the activities/project or by submitting your inquiry/request via email (iei@iii.org.tw):

1. any inquiry and request for a review of the personal information;
2. any request to make duplications of the personal information;
3. any request to supplement or correct the personal information;
4. any request to discontinue collection, processing or use of the personal information; and
5. any request to delete the personal information.
6. **The Influence on Your Rights and Interests while You Choose not to Provide Your Personal Information**

If you provide incorrect personal information or choose not to provide your personal information to IDB, IDB may not be able to provide you with services relating to the purposes prescribed above.

1. You understand that this document complies with the R.O.C. Personal Information Protection Act and relating regulations, and you agree that IDB keeps this document for further checking.

**The Consent to Provide Personal Information:**

1. I have read and understood the above notification.
2. I agreed that IDB may collect, process and use my personal information for the purposes of collection prescribed above.

Date (MM/DD/YYYY):\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_